

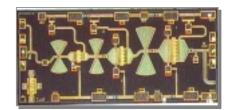
#### ADVANCED INFORMATION

### **Description**

The Raytheon RMDA29000 is a high efficiency driver amplifier designed for use in point to point radio, point to multi-point communications, LMDS and other millimeter wave applications. The RMDA29000 is a 3-stage GaAs MMIC amplifier utilizing Raytheon's advanced 0.15µm gate length Power PHEMT process and can be used in conjunction with other driver or power amplifiers to achieve the required total power output.

### **Features**

- ◆ 20 dB small signal gain (typ.)
- 22 dBm saturated power out (typ.)
- Circuit contains individual source Vias
- ◆ Chip Size 3.41 mm x 1.62 mm



### Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Positive DC Voltage (+5 V Typical)	Vd	+ 6	Volts
Negative DC Voltage	Vg	- 2	Volts
Simultaneous (Vd - Vg)	Vdg	+ 8	Volts
Positive DC Current	$I_{D}$	360	mA
RF Input Power (from 50 $\Omega$ source)	$P_{IN}$	+10	dBm
Operating Base plate Temperature	T <sub>C</sub>	-30 to +85	°C
Storage Temperature Range	$T_{stg}$	-55 to +125	°C
Thermal Resistance (Channel to Backside)	$R_{jc}$	44	°C/W

### Electrical Characteristics (At 25 °C) 50 Ohm system, Vd=+5V, Quiescent current (Idq)=250 mA

Parameter	Min	Тур	Max	Unit
Frequency Range	27		31	GHz
Gate Supply Voltage <sup>1</sup> (Vg)		-0.4		V
Gain Small Signal	15	20	30	dB
Gain Variation				
vs. Frequency		+/-1		dB
Power Output at 1 dB				
Compression		21		dBm
Power Output Saturated:				
(Pin=+5 dBm)		22		dBm

Parameter	Min	Тур	Max	Unit
Drain Current Small Signal		250		mA
Drain Current at P1				
dB Compression		270		mA
Power Added Efficiency				
(PAE): at P1dB		8		%
OIP3		29		dBm
Input Return Loss	5	10		dB
Output Return Loss	5	8		dB

#### Note:

1. Typical range of the negative gate voltages is -0.9 to 0.0V to set typical Idq of 250 mA.

ADVANCED INFORMATION

### **Application Information**

#### CAUTION: THIS IS AN ESD SENSITIVE DEVICE.

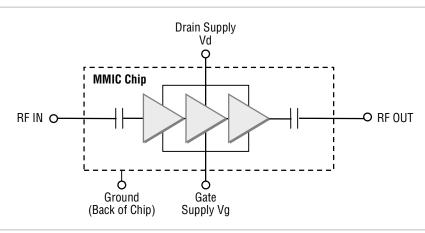
Chip carrier material should be selected to have GaAs compatible thermal coefficient of expansion and high thermal conductivity such as copper molybdenum or copper tungsten. The chip carrier should be machined, finished flat, plated with gold over nickel and should be capable of withstanding 325°C for 15 minutes.

Die attachment for power devices should utilize Gold/Tin (80/20) eutectic alloy solder and should avoid hydrogen environment for PHEMT devices. Note that the backside of the chip is gold plated and is used as RF and DC Ground.

These GaAs devices should be handled with care and stored in dry nitrogen environment to prevent contamination of bonding surfaces. These are ESD sensitive devices and should be handled with appropriate precaution including the use of wrist-grounding straps. All die attach and wire/ribbon bond equipment must be well grounded to prevent static discharges through the device.

Recommended wire bonding uses 3 mils wide and 0.5 mil thick gold ribbon with lengths as short as practical allowing for appropriate stress relief. The RF input and output bonds should be typically 0.012" long corresponding to a typically 2 mils gap between the chip and the substrate material.

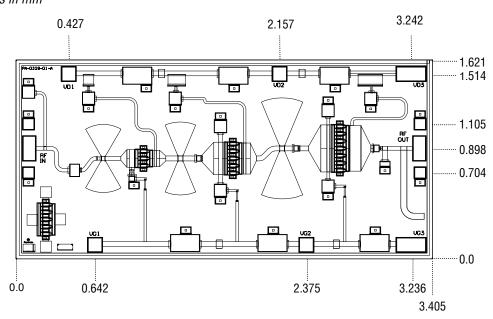
### Figure 1 Functional Block Diagram



# Figure 2 Chip Layout and Bond Pad Locations

(Chip Size=3.405 mm x 1.621 mm x 50 μm. Back of Chip is RF and DC Ground)

### Dimensions in mm



ADVANCED INFORMATION

Figure 3
Recommended
Application Schematic
Circuit Diagram

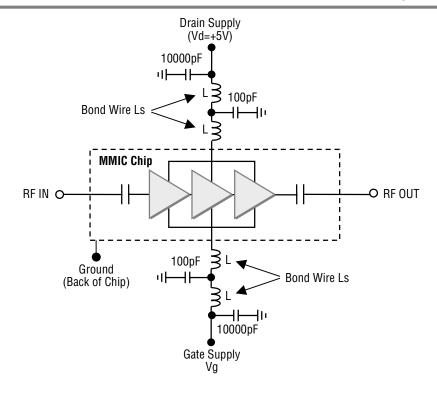
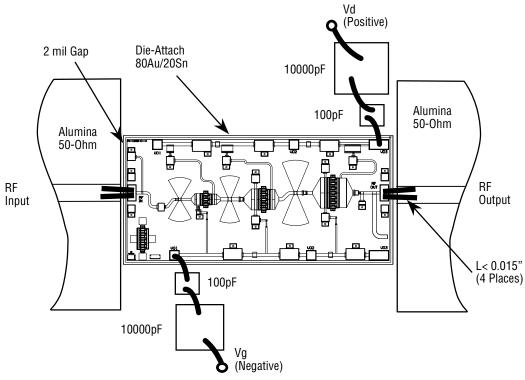


Figure 4
Recommended
Assembly Diagram



#### Note

Use 0.003" x 0.0005" Gold Ribbon for bonding. RF input and output bonds should be less than 0.015" long with stress relief. Vds should biased from 1 supply as shown. Vgs should be biased from 1 supply.



ADVANCED INFORMATION

### Recommended Procedure for Biasing and

Operation

### CAUTION: LOSS OF GATE VOLTAGE (VG) WHILE DRAIN VOLTAGE (VD) IS PRESENT MAY DAMAGE THE AMPLIFIER CHIP.

The following sequence of steps must be followed to properly test the amplifier.

Step 1: Turn off RF input power.

**Step 2:** Connect the DC supply grounds to the ground of the chip carrier.

Slowly apply negative gate bias supply voltage of -1.5 V to Vg.

**Step 3:** Slowly apply positive drain bias supply voltage of +5 V to Vd.

**Step 4:** Adjust gate bias voltage to set the quiescent current of Idg=250 mA.

**Step 5:** After the bias condition is established, the RF

input signal may now be applied at the appropriate frequency band.

**Step 6:** Follow turn-off sequence of:

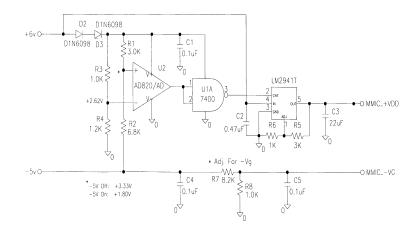
(i) Turn off RF input power.

(ii) Turn down and off drain voltage (Vd).

(iii) Turn down and off gate bias voltage (Vg).

#### Note:

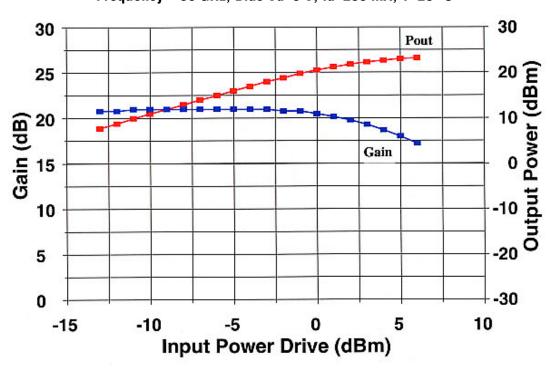
An example auto bias sequencing circuit to apply negative gate voltage and positive drain voltage for the above procedure is shown below.



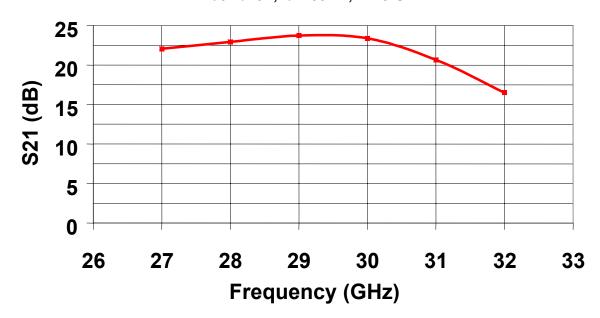
ADVANCED INFORMATION

### Performance Data

RMDA29000 Gain, Power Out Vs. Power In Frequency = 30 GHz, Bias Vd=5 V, Id=250 mA, T=25  $^{\circ}$ C

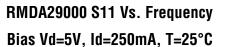


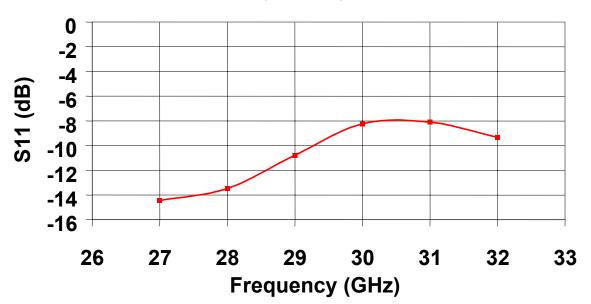
RMDA29000 S21 Vs. Frequency Bias Vd=5V, Id=250mA, T=25°C



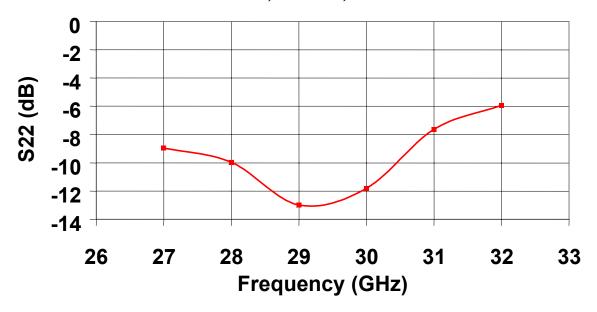
ADVANCED INFORMATION

Performance Data





RMDA29000 S22 Vs. Frequency Bias Vd=5V, Id=250mA, T=25°C



Raytheon

# Worldwide Sales Representatives

#### ADVANCED INFORMATION

#### **North America**

D&L Technical Sales

6139 S. Rural Road, #102 Tempe, AZ 85283 480-730-9553 fax: 480-730-9647 Nicholas Delvecchio, Jr. dlarizona@aol.com

Steward Technology

89 St. Beatrice Ct.
Danville, CA 94526
408-568-9159
fax: 925-820-7481
John Steward
johnsteward1@msn.com

Midwin & Olifison

5567 Resada Blvd, Suite 315 Tarzana, CA 91356 818-996-9093 fax: 818-996-9650 Ronald Midwin midwin@mo-rep.com

Spartech South

2115 Palm Bay Road, NE, Suite 4 Palm Bay, FL 32904 321-727-8045 fax: 321-727-8086 Jim Morris jim@spartech-south.com TEQ Sales. Inc.

920 Davis Road, Suite 304 Elgin, IL 60123 847-742-3767 fax: 847-742-3947 Dennis Culpepper dculpepper@teqsales.com

Hi-Peak Technical Sales

P.O. Box 6067 Amherst, NH 03031 866-230-5453 fax: 603-672-9228 sales@hi-peak.com Cantec Representatives

8 Strathearn Ave, No. 18 Brampton, Ontario Canada L6T 4L9 905-791-5922 fax: 905-791-7940 Dave Batten cantec-ott@cantec-o.net

Technical Marketing Inc.

3320 Wiley Post Road Carrollton, TX 75006 972-387-3601 fax: 972-387-3605 Bill Stoffregen billstoff@tmisales.com

### Europe

Sangus OY

Lunkintie 21, 90460 Oulunsalo Finland 358-8-8251-100 fax: 358-8-8251-110 Juha Virtala juha.virtala@sangus.fi

Globes Elektronik & Co.

Klarastrabe 12 74072 Heilbronn Germany 49-7131-7810-0 fax: 49-7131-7810-20 Ulrich Blievernicht hfwelt@globes.de MTI Engineering Limited

Afek Industrial Park Hamelacha 11 New Industrial Area Rosh Hayin 48091 Israel 972-3-902-5555 fax: 972-3-902-556 Adi Peleg adi p@mti-group.co.il Sirces srl

Via C. Boncompagni, 3B 20139 Milano Italy 3902-57404785 fax: 3902-57409243 Nicola lacovino nicola.iacovino@sirces.it Sangus AB

Berghamnvagen 68 Box 5004 S-165 10 Hasselby Sweden Ronny Gustafson 468-0-380210 fax: 468-0-3720954

#### Asia

ITX Corporation

2-5, Kasumigaseki 3- Chome Chiyoda-Ku Tokyo 100-6014 Japan 81-3-4288-7073 fax: 81-3-4288-7243 Maekawa Ryosuke maekawa.ryosuke@itx-corp.co.jp Sea Union

10F, Building A, No 116 Sec 1, Hsin-Tai 5th Road Hsichih, Taipei, Taiwan, ROC 886-2-2696-2986 fax: 886-2-2696-3061 Murphy Su seaunion@ms2.hinet.net **Worldwide Distributor** 

AVNET-MCS 6321 San Ignacio Drive San Jose, CA 95119 408-360-4073 fax: 408-281-8802 Art Herbig art.herbig@avnet.com

### Sales Office Headquarters

United States

(East Coast)
Raytheon
362 Lowell Street
Andover, MA 01810
978-684-8628
fax: 978-684-8646
Walter Shelmet
wshelmet
@rrfc.raytheon.com

**United States** 

(West Coast)
Raytheon
362 Lowell Street
Andover, MA 01810
978-684-8919
fax: 978-684-8646
Rob Sinclair
robert\_w\_sinclair
@rrfc.raytheon.com

Europe

Raytheon AM Teckenberg 53 40883 Ratingen Germany 49-2102-706-155 fax: 49-2102-706-156 Peter Hales peter\_j\_hales @raytheon.com **∆cia** 

Raytheon Room 601, Gook Je Ctr. Bldg 191 Hangang Ro 2-GA Yongsan-Gu, Seoul, Korea 140-702 82-2-796-5797 fax: 82-2-796-5790 T.G. Lee tg\_lee@rrfc.raytheon.com

Customer Support

978-684-8900 fax: 978-684-5452

customer\_support@rrfc.raytheon.com